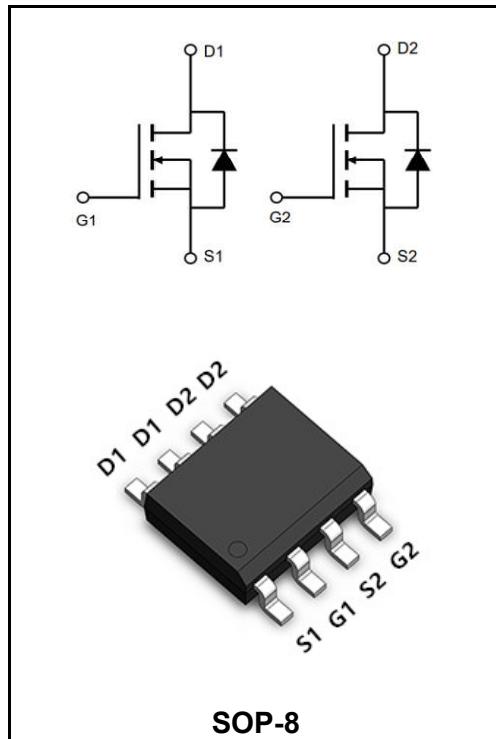


40V N+N-CHANNEL ENHANCEMENT MODE MOSFET
MAIN CHARACTERISTICS

I_D	20A
V_{DSS}	40V
$R_{DS(on)-typ}(@V_{GS}=10V)$	< 10.5mΩ (Type: 8.5 mΩ)


Application

- ◆ Battery protection
- ◆ Load switch
- ◆ Uninterruptible power supply

Product Specification Classification

Part Number	Package	Marking	Pack
YFW20H04S	SOP-8	YFW 20H04S XXXXX	3000PCS/Tape

Maximum Ratings at $T_c=25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	40	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS} @ 10V^1 @ T_A=25^\circ\text{C}$	I_D	20	A
Continuous Drain Current, $V_{GS} @ 10V^1 @ T_A=70^\circ\text{C}$	I_D	10.2	A
Pulsed Drain Current ²	I_{DM}	60	A
Single Pulse Avalanche Energy ³	E_{AS}	51	mJ
Avalanche Current	I_{AS}	25	A
Total Power Dissipation ⁴ @ $T_A=25^\circ\text{C}$	P_D	1.5	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-ambient (Steady State) ¹	$R_{\theta JA}$	85	°C/W
Thermal Resistance Junction-Case1	$R_{\theta JC}$	36	°C/W

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	B _{VDSS}	40	-	-	V
BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA	ΔB _{VDSS/ΔTJ}	-	0.034	-	V/°C
Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =6A	R _{DS(ON)}	-	8.5	10.5	mΩ
	V _{GS} =4.5V, I _D =3A		-	11.0	15	
Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	V _{GS(th)}	1.0	-	2.5	V
V _{GS(th)} Temperature Coefficient		ΔV _{GS(th)}	-	-5.64	-	mV/°C
Drain-Source Leakage Current	V _{DS} =32V, V _{GS} =0V T _J =25°C	I _{DSS}	-	-	1	uA
	V _{DS} =32V , V _{GS} =0V , T _J =55°C		-	-	5	
Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Forward Transconductance	V _{DS} = 5V, I _D = 6A	g _{fs}	-	31	-	S
Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	R _g		2.1	-	Ω
Total Gate Charge (4.5V)	V _{DS} =20V V _{GS} =4.5V I _D =6A	Q _g	-	10.7	-	nC
Gate-Source Charge		Q _{gs}	-	3.3	-	
Gate-Drain Charge		Q _{gd}	-	4.2	-	
Turn-on delay time	V _{DD} =12V V _{GS} =10V R _G = 3.3 I _D = 6A	t _{d(on)}	-	8.6	-	ns
Rise Time		T _r	-	3.4	-	
Turn-Off Delay Time		t _{d(OFF)}	-	25	-	
Fall Time		t _f	-	2.2	-	
Input Capacitance	V _{DS} =15V V _{GS} =0V f=1.0MHz	C _{iss}	-	1314	-	pF
Output Capacitance		C _{oss}	-	120	-	
Reverse Transfer Capacitance		C _{rss}	-	88	-	
Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	I _s	-	-	7.5	A
Pulsed Source Current ^{2,5}		I _{SM}	-	-	30	A
Diode Forward Voltage ²	V _{GS} =0V , I _s =1A , T _J =25°C	V _{SD}	-	-	1.2	V

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=25A
- 4 .The power dissipation is limited by 175°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

Typical Characteristics

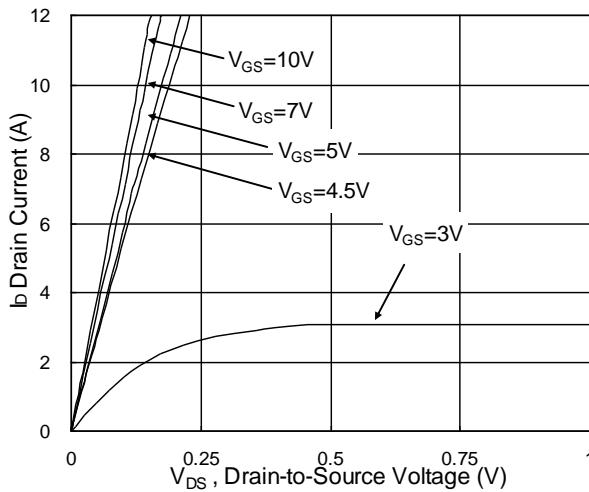


Fig.1 Typical Output Characteristics

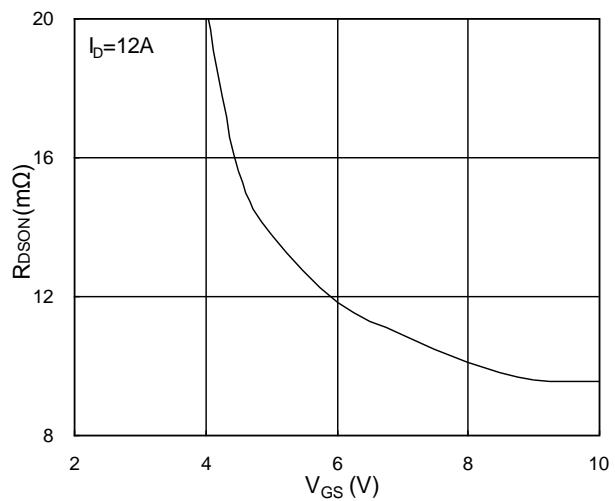


Fig.2 On-Resistance vs. G-S Voltage

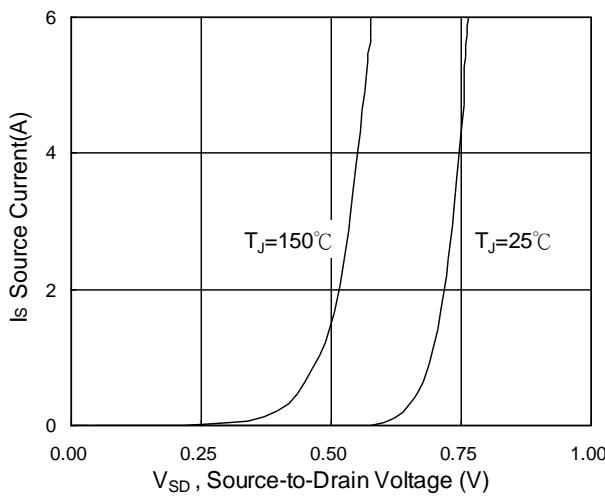


Fig.3 Forward Characteristics of Reverse

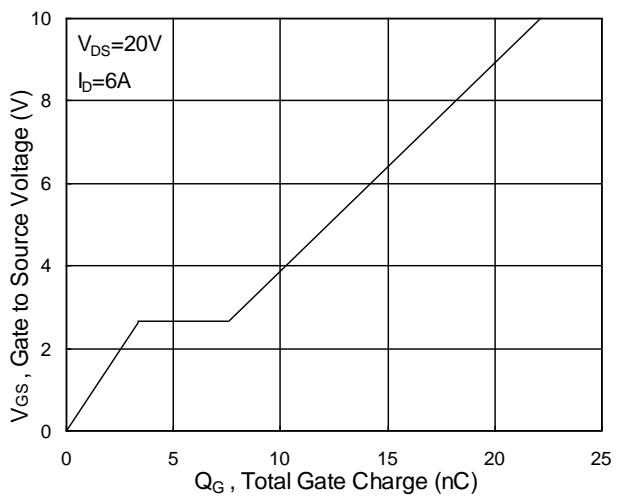


Fig.4 Gate-Charge Characteristics

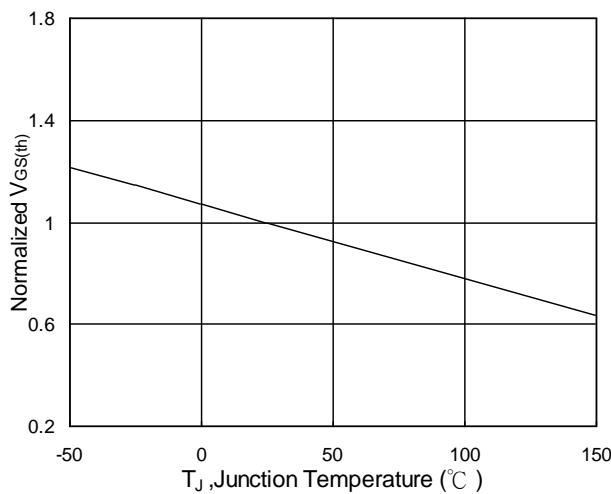


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

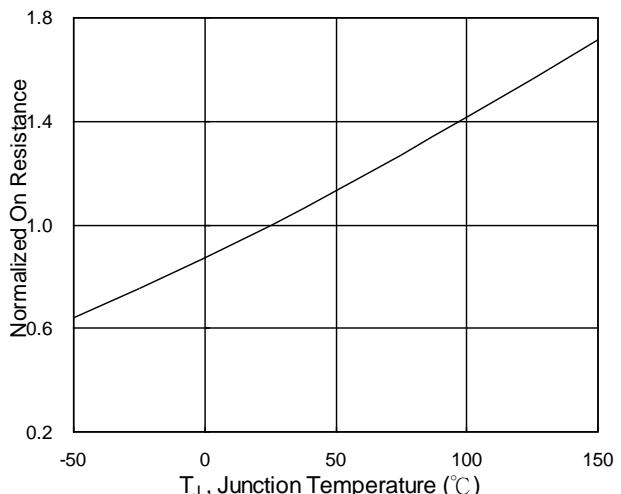
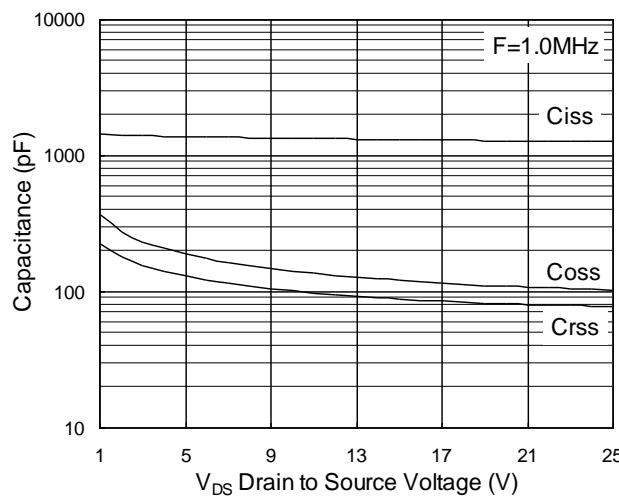
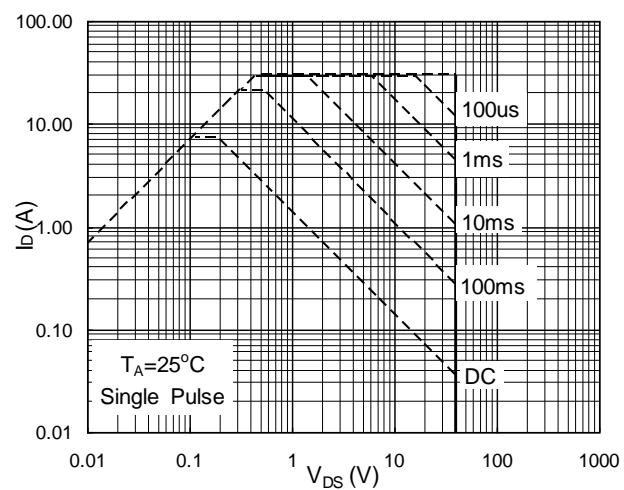
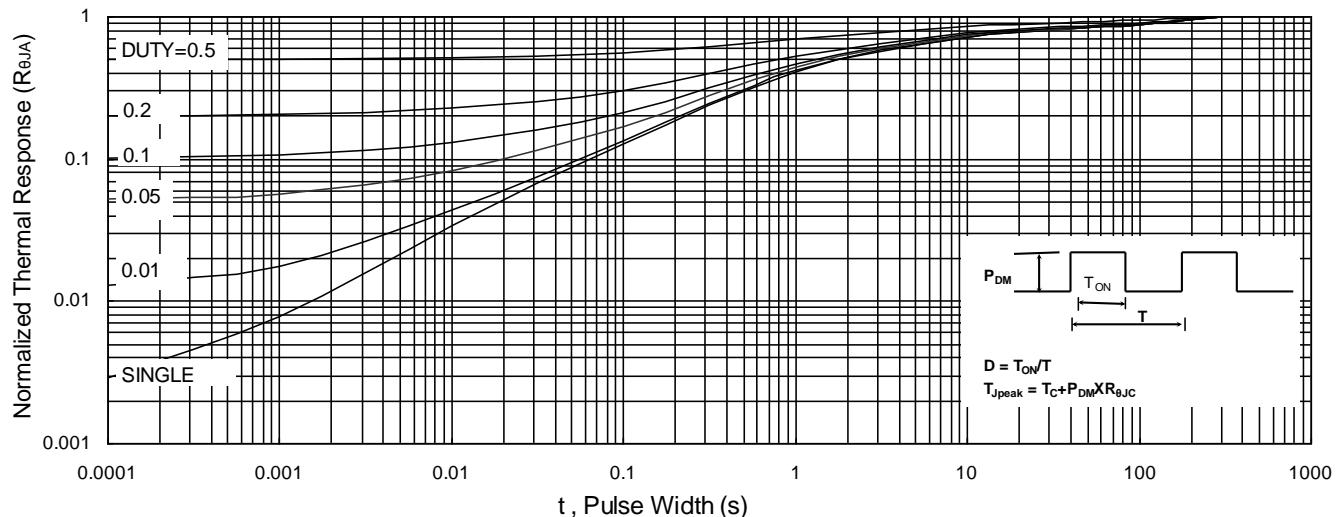
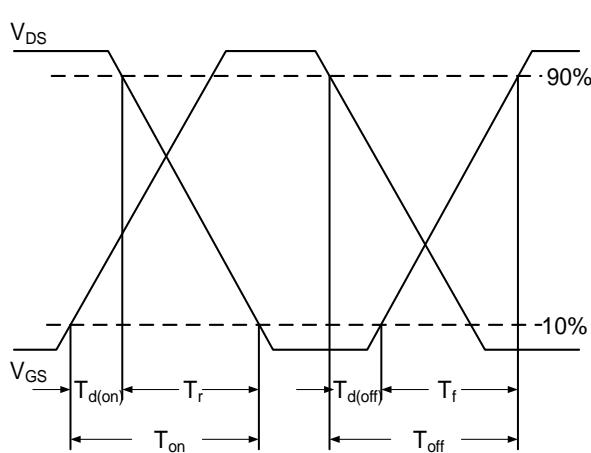
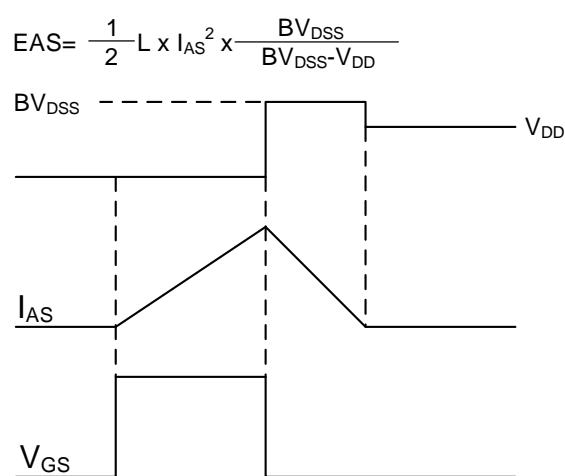
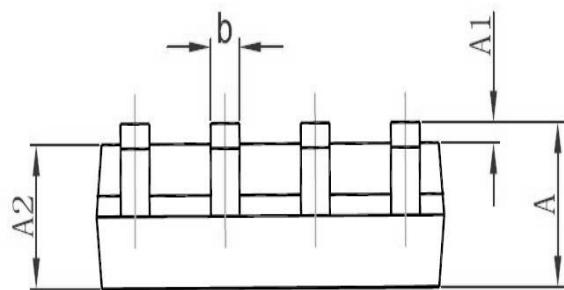
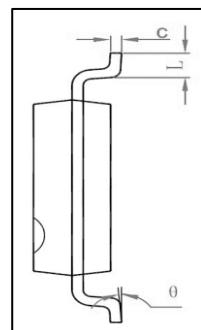
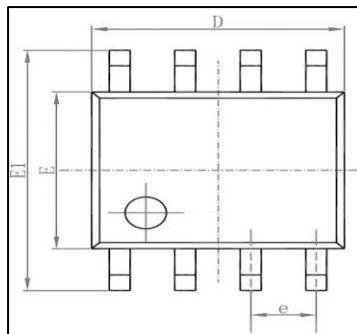


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

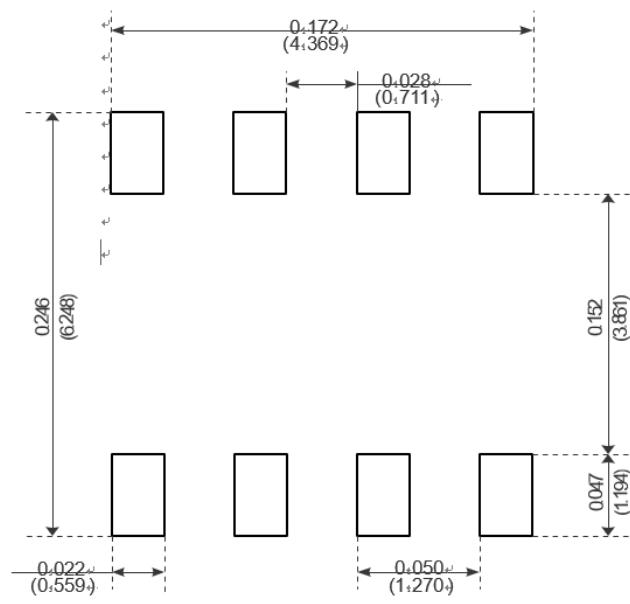
Ratings and Characteristic Curves

Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Fig.10 Switching Time Waveform

Fig.11 Unclamped Inductive Switching Waveform

Package Outline Dimensions Millimeters

SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



Recommended Minimum Pads